

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Scott M. Hayes</td><td>09/26/2011</td></tr><tr><td>Jason R. Wright</td><td>09/26/2011</td></tr></tbody></table>	Name	Execution Date	Scott M. Hayes	09/26/2011	Jason R. Wright	09/26/2011	
Name	Execution Date						
Scott M. Hayes	09/26/2011						
Jason R. Wright	09/26/2011						
RECEIVING PARTY DATA							
Name:	Freescall Semiconductor, Inc.						
Street Address:	6501 William Cannon Drive West						
Internal Address:	Law Department						
City:	Austin						
State/Country:	TEXAS						
Postal Code:	78735						
PROPERTY NUMBERS Total: 1							
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>13246990</td></tr></tbody></table>	Property Type	Number	Application Number:	13246990			
Property Type	Number						
Application Number:	13246990						
CORRESPONDENCE DATA							
Fax Number:	(512)895-6630						
Phone:	512-895-6979						
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>							
Correspondent Name:	Pat Thomas						
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Address Line 2:	TX30/OE62						
Address Line 4:	Austin, TEXAS 78735						
ATTORNEY DOCKET NUMBER:	MT11668ZK						
NAME OF SUBMITTER:	Pat Thomas						
Total Attachments: 3 source=MT11668ZK-USA-Assignment#page1.tif source=MT11668ZK-USA-Assignment#page2.tif source=MT11668ZK-USA-Assignment#page3.tif							

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REEL: 026980 FRAME: 0945

## PATENT

## ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, **SCOTT M. HAYES, CHANDLER, ARIZONA; and, JASON R. WRIGHT, CHANDLER, ARIZONA**, have sold, assigned and transferred, and do hereby sell, assign and transfer, unto **FREESCALE SEMICONDUCTOR, INC.**, a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in **CAPPED DEVICE INTERCONNECT IN A SEMICONDUCTOR PACKAGE** (Docket No. **MT11668ZK**), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto **FREESCALE SEMICONDUCTOR, INC.**, the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize **FREESCALE SEMICONDUCTOR, INC.** to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to **FREESCALE SEMICONDUCTOR, INC.**, for the sole use and benefit of **FREESCALE SEMICONDUCTOR, INC.**, its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to **FREESCALE SEMICONDUCTOR, INC.**


We agree that, when requested, we will, without charge to **FREESCALE SEMICONDUCTOR, INC.**, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in **FREESCALE SEMICONDUCTOR, INC.**, its successors, assigns and legal representatives or nominees.

We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

  
SCOTT M. HAYES

DATE: 9/26/2011

First Witness

  
SIGNATURE OF WITNESS

DATE: 9/26/2011  
(Month-Day-Year)

MICHAEL VINCENT  
PRINTED NAME OF WITNESS

Second Witness

  
SIGNATURE OF WITNESS

DATE: 9/26/2011  
(Month-Day-Year)

Zhiwei Gong  
PRINTED NAME OF WITNESS

  
JASON R. WRIGHT

DATE: 9/26/2011

### ***First Witness***

SIGNATURE OF WITNESS: Michael Vincent DATE: 9/26/2011  
(Month-Day-Year)

MICHAEL VINCENT  
PRINTED NAME OF WITNESS

### Second Witness

SIGNATURE OF WITNESS \_\_\_\_\_ DATE: 9/26/2011  
(Month-Day-Year)

Zhiwei Gong  
PRINTED NAME OF WITNESS